## MODULAR APPROVAL LETTER FCC ID: P53-EMW3090V2

Modular Approval Requirement	Yes	No
(i) The radio elements of the modular transmitter must have their own shielding. The physical crystal and tuning capacitors may be located external to the shielded radio elements.	YES The modular transmitter have its own RF shielding	
(ii) The modular transmitter musthave buffered modulation/data inputs (if such inputs are provided) to ensurethat the module will comply with part 15 requirements under conditions of excessivedata rates or over-modulation.	YES The modular accord with Part 15 requirements	
(iii) The modular transmitter musthave its own power supply regulation.	YES The modularIt has its own power supply regulation	
(iv) The modular transmitter mustcomply with the antenna and transmissionsystem requirements of §§ 15.203, 15.204(b) and 15.204(c). The antennamust either be permanently attachedor employ a "unique" antennacoupler (at all connections between themodule and the antenna, including thecable). The "professional installation" provision of § 15.203 is not applicable tomodules but can apply to limited modular approvals under paragraph (b) of this section.	YES The modular accord with the antenna requirements of Section 15.203 and 15.204(b)(c)	
(v) The modular transmitter must be tested in a stand-alone configuration	YES	
(vi) The modular transmitter must beequipped with either a permanently affixed label or must be capable of electronically displaying its FCC identification number.	YES The modular have one permanently affixed label	
(vii) The modular transmitter mustcomply with any specific rules or operatingrequirements that ordinarilyapply to a complete transmitter andthe manufacturer must provide adequateinstructions along with the moduleto explain any such requirements. A copy of these instructions must beincluded in the application for equipmentauthorization.  (viii) The modular transmitter mustcomply with any	YES The modular transmitter accord with any specific rule or operating requirements  YES	

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## Shanghai MXCHIP Information Technology Co.,Ltd.

applicable RF exposurerequirements in its final	The modular
configuration.	transmitter
	accord RF
	exposure
	requirements

The letter must be on the applicant's letterhead and signed by the grantee code contact.

## Signature:

Date: April 17, 2023

Xu Wei

XuWei / Product department manager

Shanghai MXCHIP Information Technology Co.,Ltd.